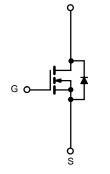


# AUIRLU3114Z-VB Datasheet N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a, c</sup>	Q <sub>g</sub> (Typ.)		
40	0.0016 at V <sub>GS</sub> = 10 V	120	120 nC		
	0.0020 at V <sub>GS</sub> = 4.5 V	100	120110		
	D				



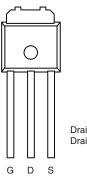
## FEATURES

- Trench Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested

#### **APPLICATIONS**

- Synchronous Rectification
- Power Supplies





Top View

TO-251

Drain Connected to Drain-Tab

N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	semive6688	40			
Gate-Source Voltage		V <sub>GS</sub>	± 25	V	
	T <sub>C</sub> = 25 °C		120 <sup>a, c</sup>	A	
Continuous Drain Current (T $= 175$ °C)	T <sub>C</sub> = 70 °C		96 <sup>c</sup>		
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>A</sub> = 25 °C	I I <sub>D</sub>	29 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		23 <sup>b</sup>		
Pulsed Drain Current	I <sub>DM</sub>	250	1		
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	96		
Single Pulse Avalanche Energy		E <sub>AS</sub>	320	mJ	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	120 <sup>a, c</sup>	A	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'S	2.6 <sup>b</sup>	A	
	T <sub>C</sub> = 25 °C		312 <sup>a</sup>		
Movimum Dowor Dissinction	T <sub>C</sub> = 70 °C		200	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.13 <sup>b</sup>		
	T <sub>A</sub> = 70 °C	1	2.0 <sup>b</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.33	0.4	0	

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 120 A.

Inless otherv	wise noted				
Symbol	Test Conditions	Min.	Тур.	Max.	Unit
<u> </u>					
V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	40			V
$\Delta V_{DS}/T_{J}$	L = 250 uA		41		mV/°C
$\Delta V_{GS(th)}/T_J$	$I_D = 230 \mu$ A		- 8		mv/°C
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.2		2.5	V
I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	
DSS	$V_{DS}$ = 40 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10	μA
I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS}$ = 10 V	120			А
Б	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		0.0016		0
RDS(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0020		Ω
9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$		180		S
C <sub>iss</sub>			9000		
C <sub>oss</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, f = 1 MHz		650		pF
C <sub>rss</sub>			450		
Qg			120	180	
Q <sub>gs</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 10 V, $I_D$ = 20 A		30		nC
Q <sub>gd</sub>			16		
Rg	f = 1 MHz		0.85	1.3	Ω
t <sub>d(on)</sub>			20	30	
t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		11	17	
t <sub>d(off)</sub>	$\rm I_D \cong 20$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 1 $\Omega$		77	115	
t <sub>f</sub>			10	15	
t <sub>d(on)</sub>			102	155	ns
t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		62	95	
t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 20 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		180	270	
t <sub>f</sub>			60	90	
6					
۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			110	А
I <sub>SM</sub>				200	~~~~
V <sub>SD</sub>	I <sub>S</sub> = 20 A		0.8	1.2	V
t <sub>rr</sub>		1	50	75	ns
	Symbol $V_{DS}$ $\Delta V_{DS}/T_J$ $\Delta V_{GS(th)}/T_J$ $V_{GS(th)}/T_J$ $V_{GS(th)}/T_J$ $V_{GS(th)}/T_J$ $I_{GSS}$ $I_{DSS}$ $I_{DSS}$ $I_{D(on)}$ $R_{DS(on)}$ $g_{fs}$ $C_{iss}$ $C_{oss}$ $C_{rss}$ $Q_{gd}$ $Q_{gd}$ $R_g$ $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $t_{d(off)}$ $t_f$ $I_S$	$\begin{tabular}{ c c c c } \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)}/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 20 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 30 \ A \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} \\ \hline Q_{g} \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 10 \ V, \ I_D = 20 \ A \\ \hline Q_{gd} \\ \hline R_{g} \\ \hline f = 1 \ MHz \\ \hline t_{d(on)} \\ t_{f} \\ \hline t_{d(on)} \\ t_{f} \\ \hline t_{d(on)} \\ t_{f} \\ \hline V_{DD} = 20 \ V, \ R_{L} = 1.0 \ \Omega \\ \hline M_{D} = 20 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \\ \hline t_{f} \\ \hline t_{d(off)} \\ \hline t_{f} \\ \hline V_{DD} = 20 \ V, \ R_{L} = 1.0 \ \Omega \\ \hline T_{C} = 20 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline t_{SM} \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 40 \\ \hline & \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 1.2 \\ \hline & & \Delta V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 1.2 \\ \hline & & V_{DS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V & V_{DS} = 40 \ V, \ V_{GS} = 0 \ V & V_{DS} = 20 \ V & V_{DS} = 40 \ V, \ V_{GS} = 0 \ V & T_J = 55 \ ^{\circ}C & 10 \\ \hline & V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & 10 \\ \hline & V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & 10 \\ \hline & V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & 10 \\ \hline & V_{DS} = 40 \ V, \ V_{GS} = 10 \ V & 120 \\ \hline & V_{GS} = 10 \ V, \ I_D = 30 \ A & 120 \\ \hline & V_{DS} = 15 \ V, \ I_D = 30 \ A & 120 \\ \hline & V_{DS} = 15 \ V, \ I_D = 30 \ A & 120 \\ \hline & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 10 \\ \hline & V_{DS} = 20 \ V, \ V_{GS} = 10 \ V, \ I_D = 20 \ A \\ \hline & Q_{gd} & & & & & & & \\ \hline & Q_{gd} & & & & & & & & \\ \hline & R_{g} & f = 1 \ MHz & & & & & & & \\ \hline & R_{g} & f = 1 \ MHz & & & & & & & & \\ \hline & t_{d(off)} & & & & & & & & & & & & \\ \hline & t_{d(off)} & & & & & & & & & & & & & \\ \hline & t_{d(off)} & & & & & & & & & & & & & & \\ \hline & t_{d(off)} & & & & & & & & & & & & & & \\ \hline & t_{d(off)} & & & & & & & & & & & & & & & \\ \hline & t_{d(off)} & & & & & & & & & & & & & & & & & & &$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 40 & 41 & 41 & 41 & 41 & 41 & 41 & 41$	$\begin{tabular}{ c c c c c } \hline $Yybol$ Test Conditions $Min. Typ. $Max. $Y_{DS}$ $V_{GS} = 0 V, $I_{D} = 250 $\mu$A $40$ $41$ $$$$$$$$$$$$$$$$$$$$$$$$$$$$$$

Notes:

Reverse Recovery Fall Time

Reverse Recovery Rise Time

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

Body Diode Reverse Recovery Charge

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

 $I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ }^\circ\text{C}$ 

Q<sub>rr</sub>

ta

t<sub>b</sub>

70

30

20

105

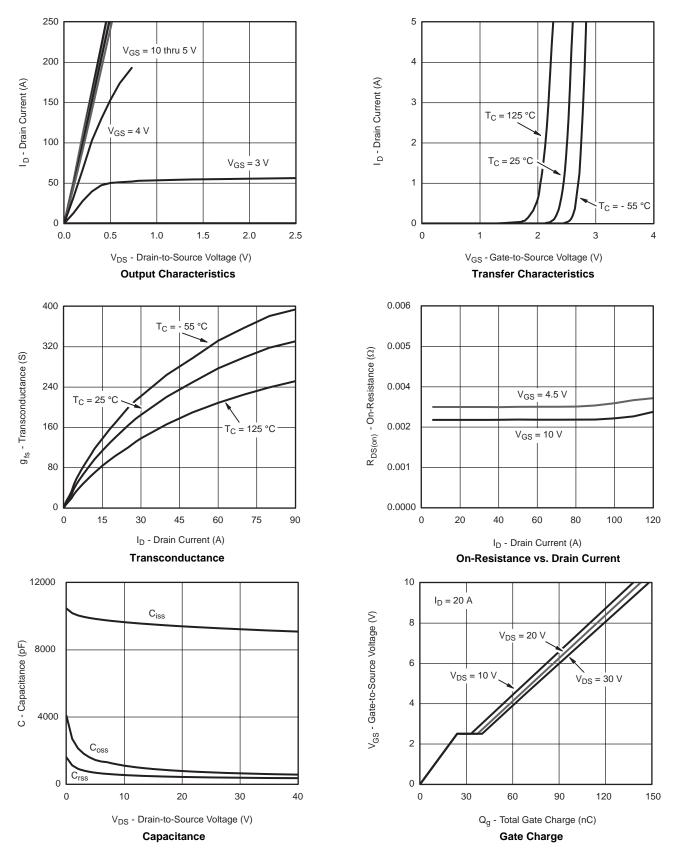
nC

ns

semi /Bsemi.com

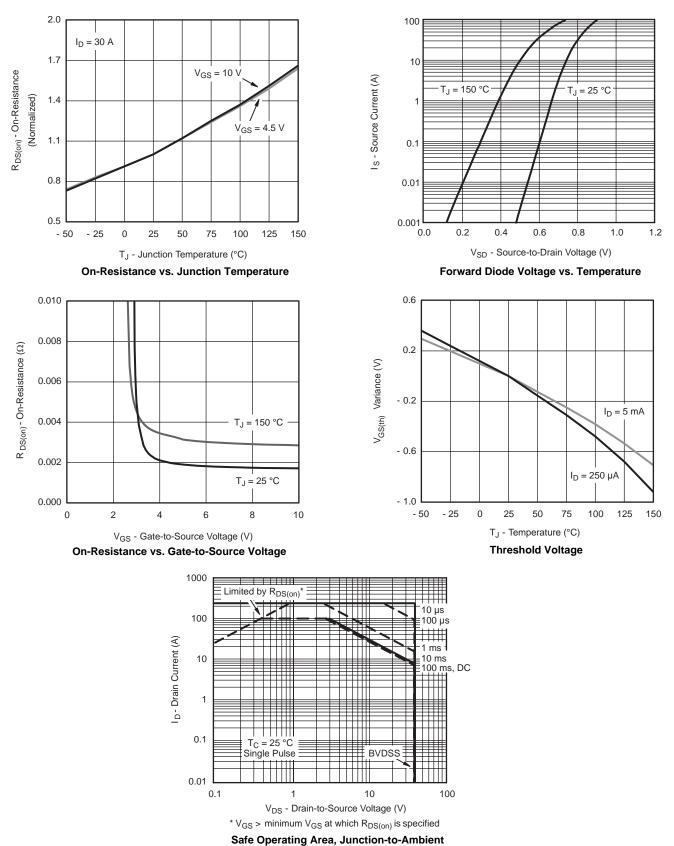


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

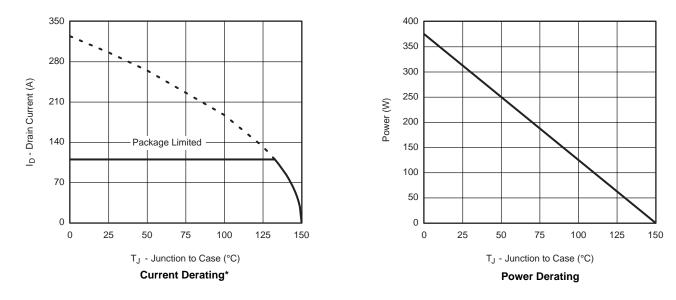




## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

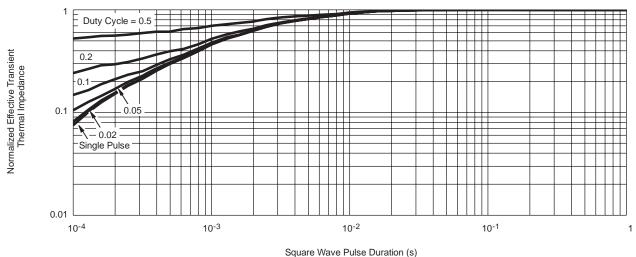






#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

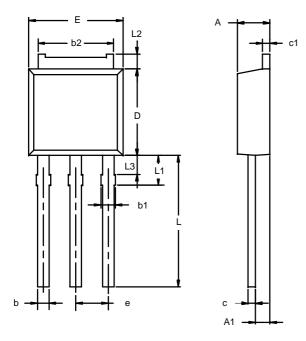


Normalized Thermal Transient Impedance, Junction-to-Case

# AUIRLU3114Z-VB



## **TO-251AA**



	MILLIMETERS			HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
c1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090 BSC	
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060

Note: Dimension L3 is for reference only.



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